

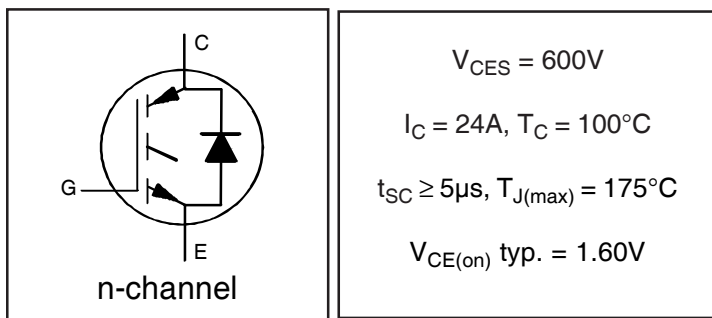
### INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

#### Features

- Low  $V_{CE(on)}$  Trench IGBT Technology
- Low Switching Losses
- 5 $\mu$ s SCSOA
- Square RBSOA
- 100% of The Parts Tested for  $I_{LM}$ ①
- Positive  $V_{CE(on)}$  Temperature Coefficient.
- Ultra Fast Soft Recovery Co-pak Diode
- Tighter Distribution of Parameters
- Lead-Free, RoHS Compliant
- Automotive Qualified \*

#### Benefits

- High Efficiency in a Wide Range of Applications
- Suitable for a Wide Range of Switching Frequencies due to Low  $V_{CE(ON)}$  and Low Switching Losses
- Rugged Transient Performance for Increased Reliability
- Excellent Current Sharing in Parallel Operation
- Low EMI

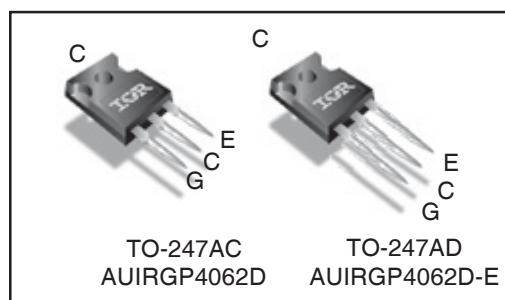


$$V_{CES} = 600V$$

$$I_C = 24A, T_C = 100^\circ C$$

$$t_{SC} \geq 5\mu s, T_{J(max)} = 175^\circ C$$

$$V_{CE(on)} \text{ typ.} = 1.60V$$



| G    | C         | E       |
|------|-----------|---------|
| Gate | Collector | Emitter |

#### Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature ( $T_A$ ) is 25°C, unless otherwise specified

|                           | Parameter                                        | Max.                              | Units      |
|---------------------------|--------------------------------------------------|-----------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage                     | 600                               | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                     | 48                                | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                     | 24                                |            |
| $I_{CM}$                  | Pulse Collector Current, $V_{GE} = 15V$          | 72                                |            |
| $I_{LM}$                  | Clamped Inductive Load Current, $V_{GE} = 20V$ ① | 96                                |            |
| $I_F @ T_C = 25^\circ C$  | Diode Continuous Forward Current                 | 48                                |            |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current                 | 24                                |            |
| $I_{FM}$                  | Diode Maximum Forward Current ③                  | 96                                | V          |
| $V_{GE}$                  | Continuous Gate-to-Emitter Voltage               | $\pm 20$                          |            |
|                           | Transient Gate-to-Emitter Voltage                | $\pm 30$                          |            |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                        | 250                               | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                        | 125                               |            |
| $T_J$                     | Operating Junction and                           | -55 to +175                       | $^\circ C$ |
| $T_{STG}$                 | Storage Temperature Range                        |                                   |            |
|                           | Soldering Temperature, for 10 sec.               | 300 (0.063 in. (1.6mm) from case) |            |
|                           | Mounting Torque, 6-32 or M3 Screw                | 10 lbf-in (1.1 N-m)               |            |

#### Thermal Resistance

|                         | Parameter                                                              | Min. | Typ. | Max. | Units        |
|-------------------------|------------------------------------------------------------------------|------|------|------|--------------|
| $R_{\theta JC}$ (IGBT)  | Thermal Resistance Junction-to-Case-(each IGBT) TO-247                 | —    | —    | 0.65 | $^\circ C/W$ |
| $R_{\theta JC}$ (Diode) | Thermal Resistance Junction-to-Case-(each Diode) TO-247                | —    | —    | 1.62 |              |
| $R_{\theta CS}$         | Thermal Resistance, Case-to-Sink (flat, greased surface)-TO-247        |      | 0.24 |      |              |
| $R_{\theta JA}$         | Thermal Resistance, Junction-to-Ambient (typical socket mount)- TO-247 | —    | 40   | —    |              |

\*Qualification standards can be found at <http://www.irf.com/>

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

|                                 | Parameter                               | Min. | Typ. | Max.      | Units                | Conditions                                                                   | Ref.Fig   |
|---------------------------------|-----------------------------------------|------|------|-----------|----------------------|------------------------------------------------------------------------------|-----------|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage  | 600  | —    | —         | V                    | $V_{GE} = 0V, I_C = 100\mu A$ ④                                              | CT6       |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage | —    | 0.30 | —         | V/ $^\circ\text{C}$  | $V_{GE} = 0V, I_C = 1mA$ (25 $^\circ\text{C}$ -175 $^\circ\text{C}$ )        | CT6       |
| $V_{CE(on)}$                    | Collector-to-Emitter Saturation Voltage | —    | 1.60 | 1.95      | V                    | $I_C = 24A, V_{GE} = 15V, T_J = 25^\circ\text{C}$                            | 5, 6, 7   |
|                                 |                                         | —    | 2.03 | —         |                      | $I_C = 24A, V_{GE} = 15V, T_J = 150^\circ\text{C}$                           | 9, 10, 11 |
|                                 |                                         | —    | 2.04 | —         |                      | $I_C = 24A, V_{GE} = 15V, T_J = 175^\circ\text{C}$                           |           |
| $V_{GE(th)}$                    | Gate Threshold Voltage                  | 4.0  | —    | 6.5       | V                    | $V_{CE} = V_{GE}, I_C = 700\mu A$                                            | 9, 10,    |
| $\Delta V_{GE(th)}/\Delta T_J$  | Threshold Voltage temp. coefficient     | —    | -18  | —         | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}, I_C = 1.0mA$ (25 $^\circ\text{C}$ - 175 $^\circ\text{C}$ ) | 11, 12    |
| $g_{fe}$                        | Forward Transconductance                | —    | 17   | —         | S                    | $V_{CE} = 50V, I_C = 24A, PW = 80\mu s$                                      |           |
| $I_{CES}$                       | Collector-to-Emitter Leakage Current    | —    | 2.0  | 25        | $\mu A$              | $V_{GE} = 0V, V_{CE} = 600V$                                                 |           |
|                                 |                                         | —    | 775  | —         |                      | $V_{GE} = 0V, V_{CE} = 600V, T_J = 175^\circ\text{C}$                        |           |
| $V_{FM}$                        | Diode Forward Voltage Drop              | —    | 1.80 | 2.6       | V                    | $I_F = 24A$                                                                  | 8         |
|                                 |                                         | —    | 1.28 | —         |                      | $I_F = 24A, T_J = 175^\circ\text{C}$                                         |           |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current         | —    | —    | $\pm 100$ | nA                   | $V_{GE} = \pm 20V$                                                           |           |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

|              | Parameter                            | Min.        | Typ. | Max. | Units   | Conditions                                                                                                   | Ref.Fig        |
|--------------|--------------------------------------|-------------|------|------|---------|--------------------------------------------------------------------------------------------------------------|----------------|
| $Q_g$        | Total Gate Charge (turn-on)          | —           | 50   | 75   | nC      | $I_C = 24A$                                                                                                  | 24             |
| $Q_{ge}$     | Gate-to-Emitter Charge (turn-on)     | —           | 13   | 20   |         | $V_{GE} = 15V$                                                                                               | CT1            |
| $Q_{gc}$     | Gate-to-Collector Charge (turn-on)   | —           | 21   | 31   |         | $V_{CC} = 400V$                                                                                              |                |
| $E_{on}$     | Turn-On Switching Loss               | —           | 115  | 201  | $\mu J$ | $I_C = 24A, V_{CC} = 400V, V_{GE} = 15V$                                                                     | CT4            |
| $E_{off}$    | Turn-Off Switching Loss              | —           | 600  | 700  |         | $R_G = 10\Omega, L = 200\mu H, L_S = 150nH, T_J = 25^\circ\text{C}$                                          |                |
| $E_{total}$  | Total Switching Loss                 | —           | 715  | 901  |         | Energy losses include tail & diode reverse recovery                                                          |                |
| $t_{d(on)}$  | Turn-On delay time                   | —           | 41   | 53   | ns      | $I_C = 24A, V_{CC} = 400V, V_{GE} = 15V$                                                                     | CT4            |
| $t_r$        | Rise time                            | —           | 22   | 31   |         | $R_G = 10\Omega, L = 200\mu H, L_S = 150nH, T_J = 25^\circ\text{C}$                                          |                |
| $t_{d(off)}$ | Turn-Off delay time                  | —           | 104  | 115  |         |                                                                                                              |                |
| $t_f$        | Fall time                            | —           | 29   | 41   |         |                                                                                                              |                |
| $E_{on}$     | Turn-On Switching Loss               | —           | 420  | —    | $\mu J$ | $I_C = 24A, V_{CC} = 400V, V_{GE} = 15V$                                                                     | 13, 15         |
| $E_{off}$    | Turn-Off Switching Loss              | —           | 840  | —    |         | $R_G = 10\Omega, L = 200\mu H, L_S = 150nH, T_J = 175^\circ\text{C}$ ④                                       | CT4            |
| $E_{total}$  | Total Switching Loss                 | —           | 1260 | —    |         | Energy losses include tail & diode reverse recovery                                                          | WF1, WF2       |
| $t_{d(on)}$  | Turn-On delay time                   | —           | 40   | —    | ns      | $I_C = 24A, V_{CC} = 400V, V_{GE} = 15V$                                                                     | 14, 16         |
| $t_r$        | Rise time                            | —           | 24   | —    |         | $R_G = 10\Omega, L = 200\mu H, L_S = 150nH$                                                                  | CT4            |
| $t_{d(off)}$ | Turn-Off delay time                  | —           | 125  | —    |         | $T_J = 175^\circ\text{C}$                                                                                    | WF1            |
| $t_f$        | Fall time                            | —           | 39   | —    |         |                                                                                                              | WF2            |
| $C_{ies}$    | Input Capacitance                    | —           | 1490 | —    | pF      | $V_{GE} = 0V$                                                                                                | 23             |
| $C_{oes}$    | Output Capacitance                   | —           | 129  | —    |         | $V_{CC} = 30V$                                                                                               |                |
| $C_{res}$    | Reverse Transfer Capacitance         | —           | 45   | —    |         | $f = 1.0MHz$                                                                                                 |                |
| RBSOA        | Reverse Bias Safe Operating Area     | FULL SQUARE |      |      |         | $T_J = 175^\circ\text{C}, I_C = 96A$<br>$V_{CC} = 480V, V_p = 600V$<br>$R_G = 10\Omega, V_{GE} = +20V$ to 0V | 4<br>CT2       |
| SCSOA        | Short Circuit Safe Operating Area    | 5           | —    | —    | $\mu s$ | $V_{CC} = 400V, V_p = 600V$<br>$R_G = 10\Omega, V_{GE} = +15V$ to 0V                                         | 22, CT3<br>WF4 |
| $E_{rec}$    | Reverse Recovery Energy of the Diode | —           | 621  | —    | $\mu J$ | $T_J = 175^\circ\text{C}$                                                                                    | 17, 18, 19     |
| $t_{rr}$     | Diode Reverse Recovery Time          | —           | 89   | —    | ns      | $V_{CC} = 400V, I_F = 24A$                                                                                   | 20, 21         |
| $I_{rr}$     | Peak Reverse Recovery Current        | —           | 37   | —    | A       | $V_{GE} = 15V, R_G = 10\Omega, L = 200\mu H, L_S = 150nH$                                                    | WF3            |

### Notes:

- ①  $V_{CC} = 80\% (V_{CES}), V_{GE} = 20V, L = 100\mu H, R_G = 10\Omega$ .
- ② This is only applied to TO-220AB package.
- ③ Pulse width limited by max. junction temperature.
- ④ Refer to AN-1086 for guidelines for measuring  $V_{(BR)CES}$  safely.

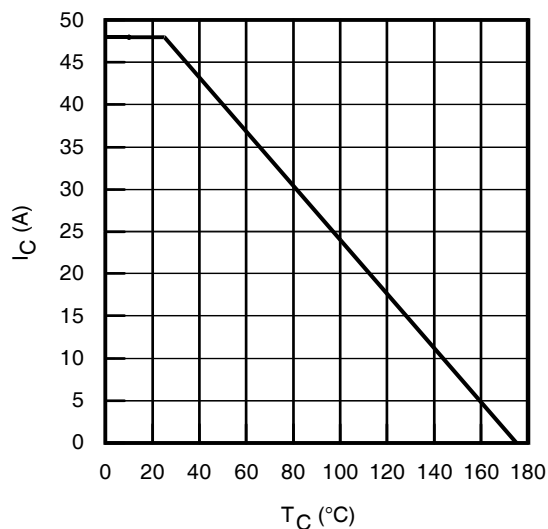
## Qualification Information<sup>†</sup>

|                            |                      |                                                                                                                                                                         |     |
|----------------------------|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|
| Qualification Level        |                      | Automotive<br>(per AEC-Q101) <sup>††</sup>                                                                                                                              |     |
|                            |                      | Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level. |     |
|                            |                      | 3L-TO-247AC                                                                                                                                                             | N/A |
| Moisture Sensitivity Level |                      | 3L-TO-247AD                                                                                                                                                             |     |
| ESD                        | Machine Model        | Class M4(+/- 400V ) <sup>†††</sup><br>(per AEC-Q101-002)                                                                                                                |     |
|                            | Human Body Model     | Class H1C(+/- 2000V ) <sup>†††</sup><br>(per AEC-Q101-001)                                                                                                              |     |
|                            | Charged Device Model | Class C5(+/- 1000V ) <sup>†††</sup><br>(per AEC-Q101-005)                                                                                                               |     |
| RoHS Compliant             |                      | Yes                                                                                                                                                                     |     |

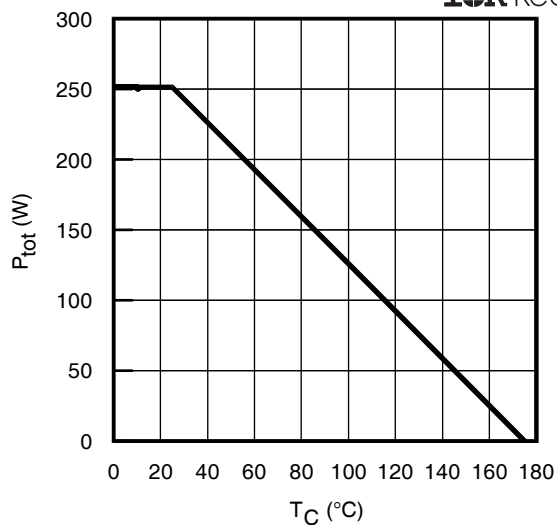
<sup>†</sup> Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/>

<sup>††</sup> Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

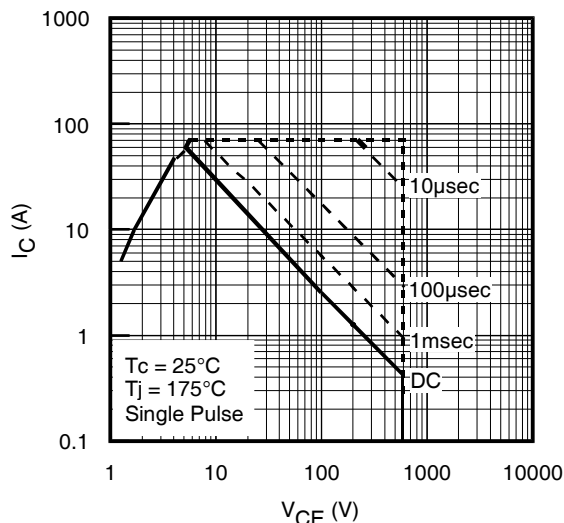
<sup>†††</sup> Highest passing voltage



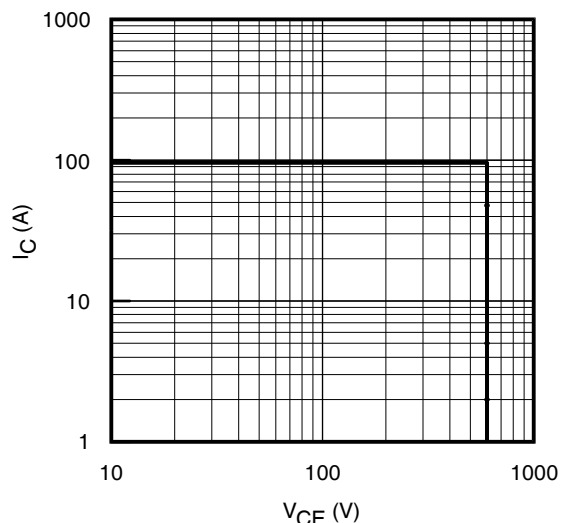
**Fig. 1** - Maximum DC Collector Current vs. Case Temperature



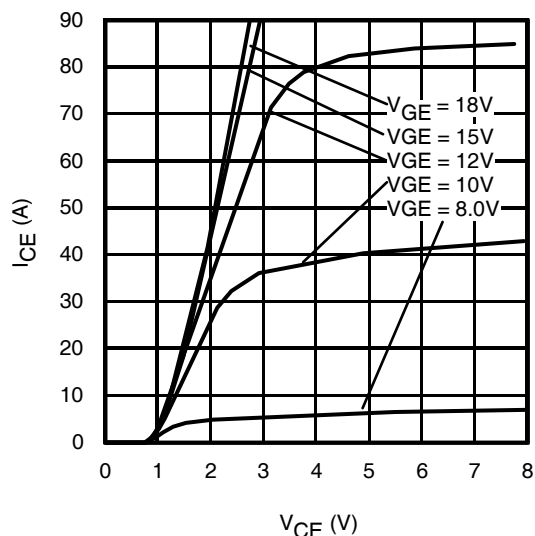
**Fig. 2** - Power Dissipation vs. Case Temperature



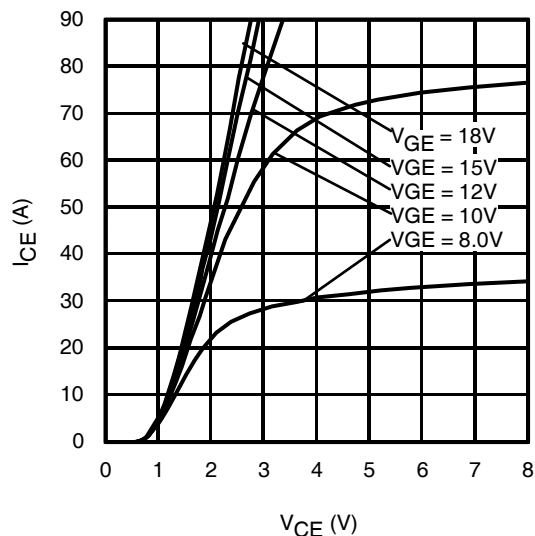
**Fig. 3** - Forward SOA  
 $T_C = 25^\circ\text{C}$ ,  $T_J \leq 175^\circ\text{C}$ ;  $V_{GE} = 15\text{V}$



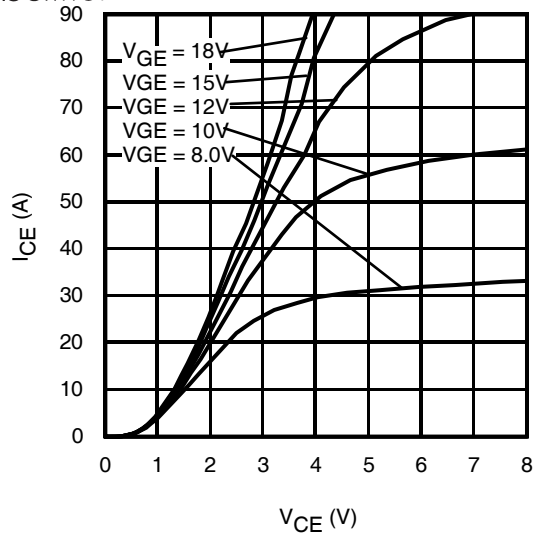
**Fig. 4** - Reverse Bias SOA  
 $T_J = 175^\circ\text{C}$ ;  $V_{GE} = 20\text{V}$



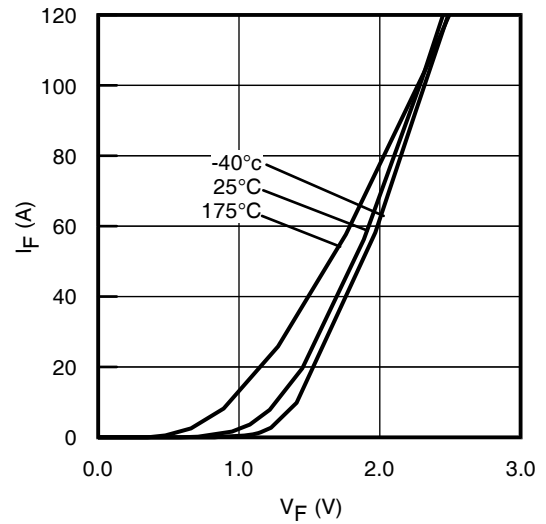
**Fig. 5** - Typ. IGBT Output Characteristics  
 $T_J = -40^\circ\text{C}$ ;  $t_p = 80\mu\text{s}$



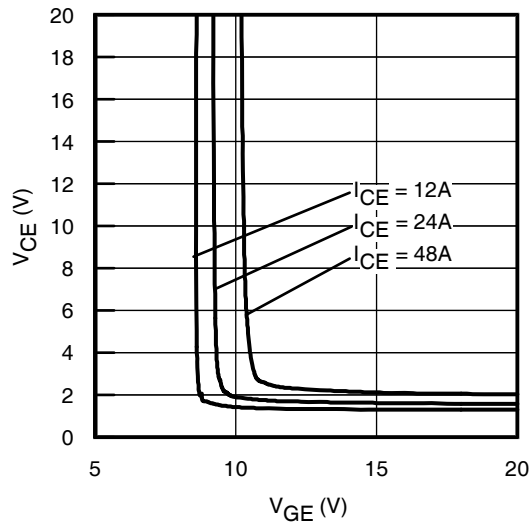
**Fig. 6** - Typ. IGBT Output Characteristics  
 $T_J = 25^\circ\text{C}$ ;  $t_p = 80\mu\text{s}$



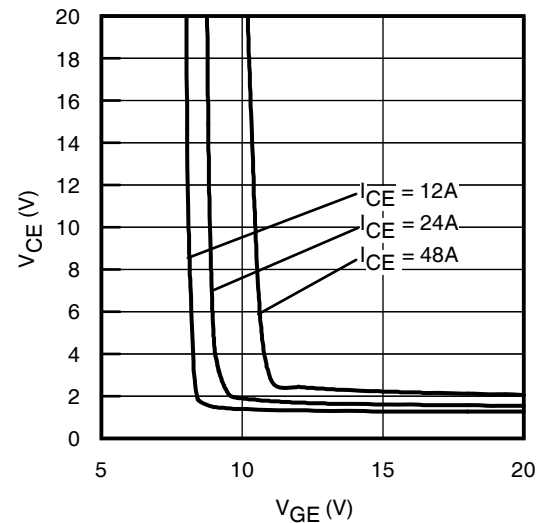
**Fig. 7** - Typ. IGBT Output Characteristics  
 $T_J = 175^\circ\text{C}$ ;  $t_p = 80\mu\text{s}$



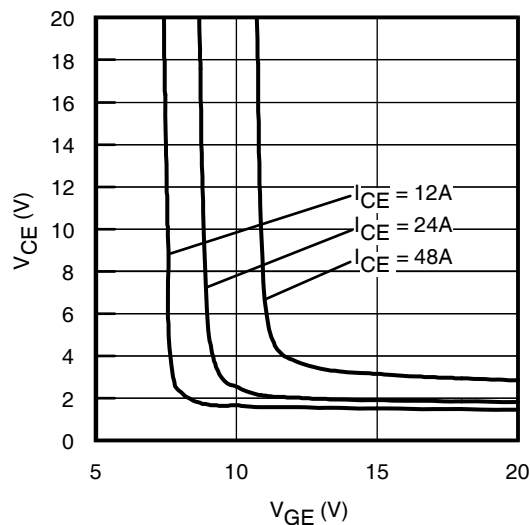
**Fig. 8** - Typ. Diode Forward Characteristics  
 $t_p = 80\mu\text{s}$



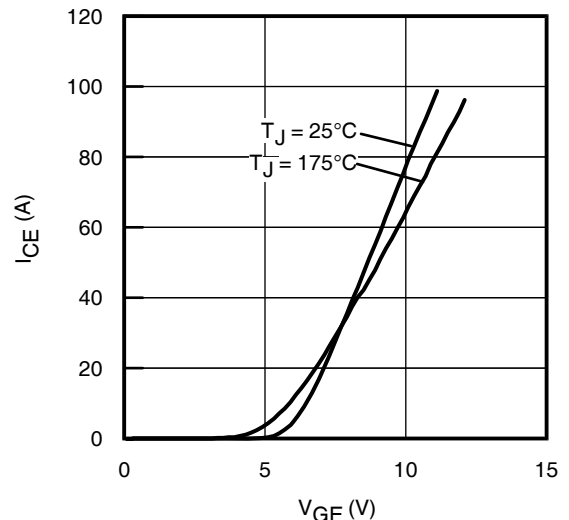
**Fig. 9** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = -40^\circ\text{C}$



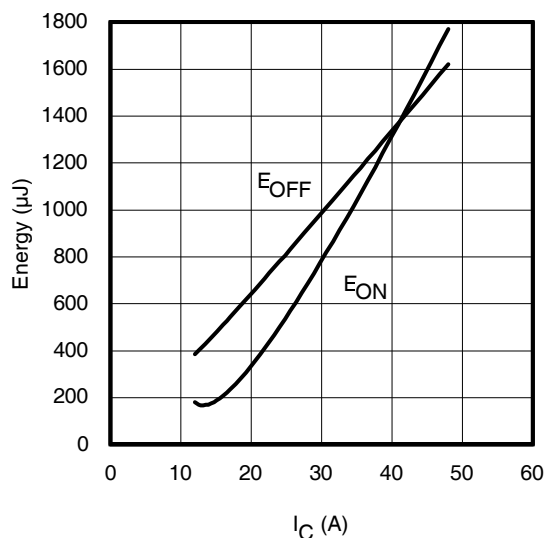
**Fig. 10** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 25^\circ\text{C}$



**Fig. 11** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 175^\circ\text{C}$

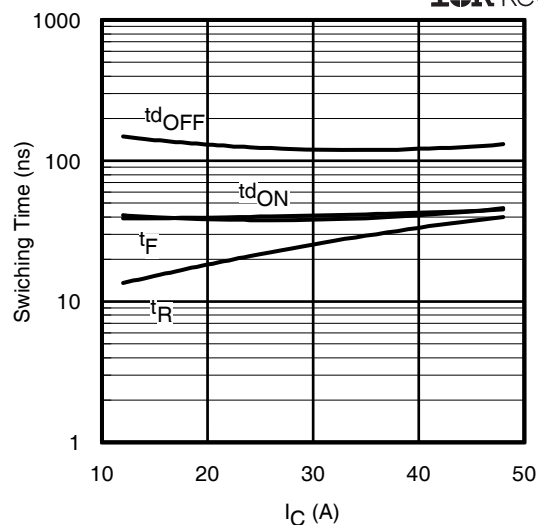


**Fig. 12** - Typ. Transfer Characteristics  
 $V_{CE} = 50\text{V}$ ;  $t_p = 10\mu\text{s}$



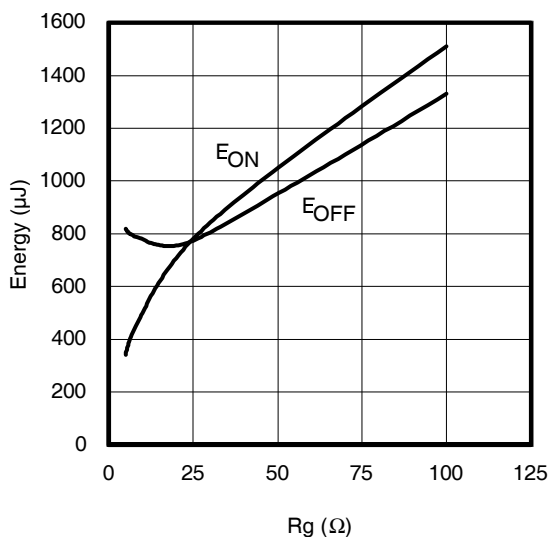
**Fig. 13** - Typ. Energy Loss vs.  $I_C$

$T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $R_G = 10\Omega$ ;  $V_{GE} = 15\text{V}$



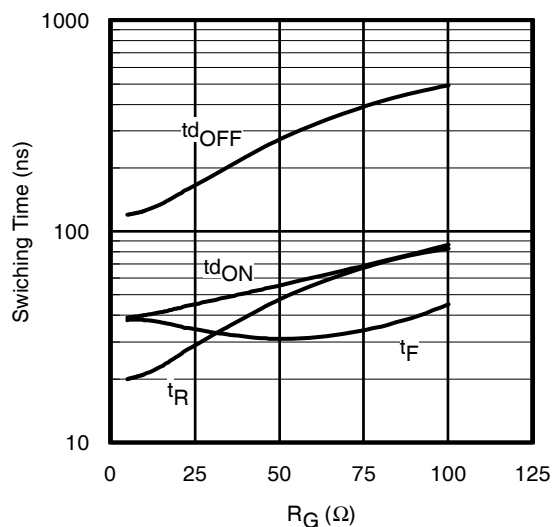
**Fig. 14** - Typ. Switching Time vs.  $I_C$

$T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $R_G = 10\Omega$ ;  $V_{GE} = 15\text{V}$



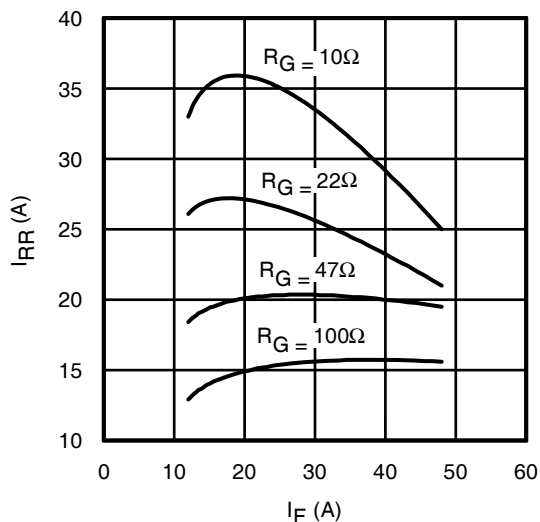
**Fig. 15** - Typ. Energy Loss vs.  $R_G$

$T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $I_{CE} = 24\text{A}$ ;  $V_{GE} = 15\text{V}$



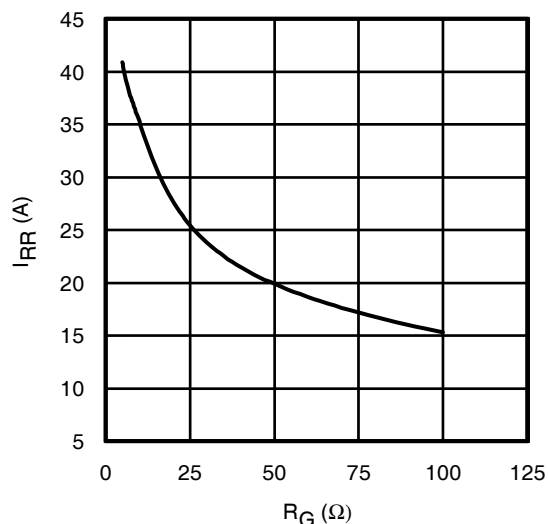
**Fig. 16** - Typ. Switching Time vs.  $R_G$

$T_J = 175^\circ\text{C}$ ;  $L = 200\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $I_{CE} = 24\text{A}$ ;  $V_{GE} = 15\text{V}$



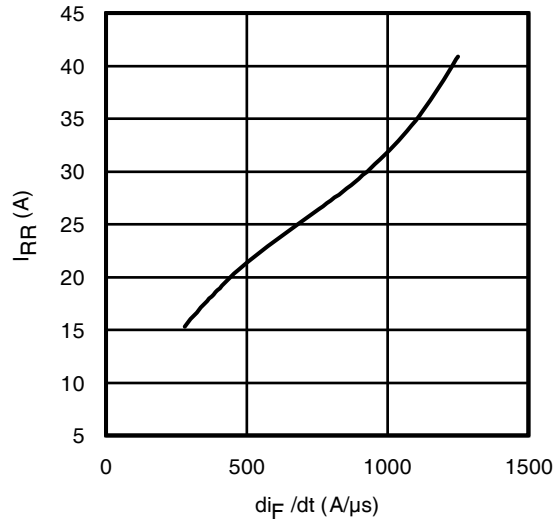
**Fig. 17** - Typ. Diode  $I_{RR}$  vs.  $I_F$

$T_J = 175^\circ\text{C}$

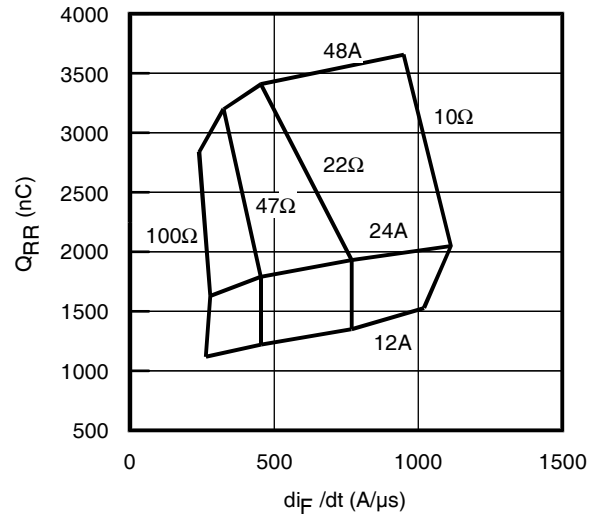


**Fig. 18** - Typ. Diode  $I_{RR}$  vs.  $R_G$

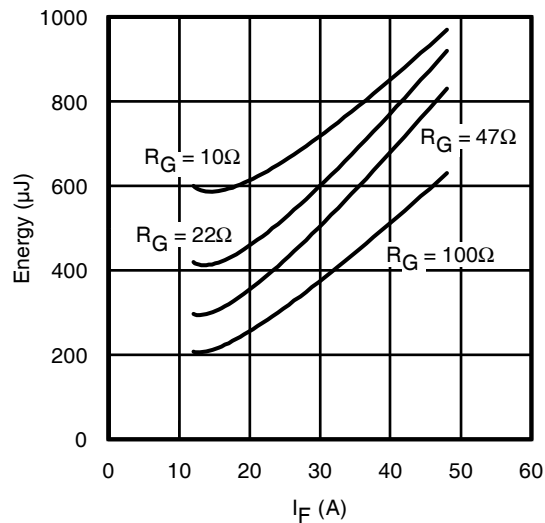
$T_J = 175^\circ\text{C}$



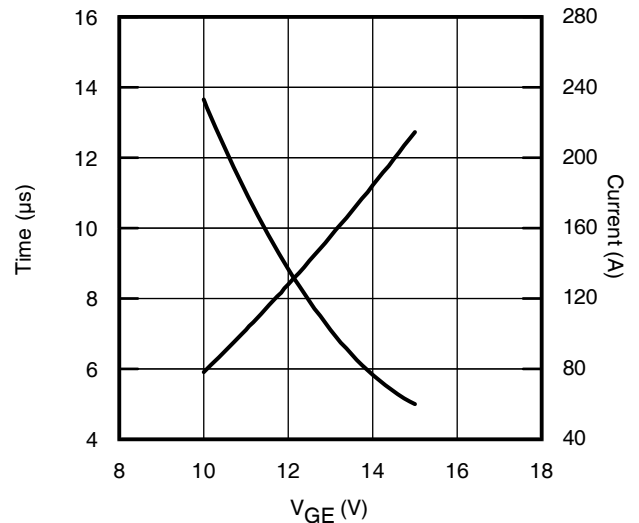
**Fig. 19** - Typ. Diode  $I_{RR}$  vs.  $di_F/dt$   
 $V_{CC} = 400V$ ;  $V_{GE} = 15V$ ;  $I_F = 24A$ ;  $T_J = 175^\circ C$



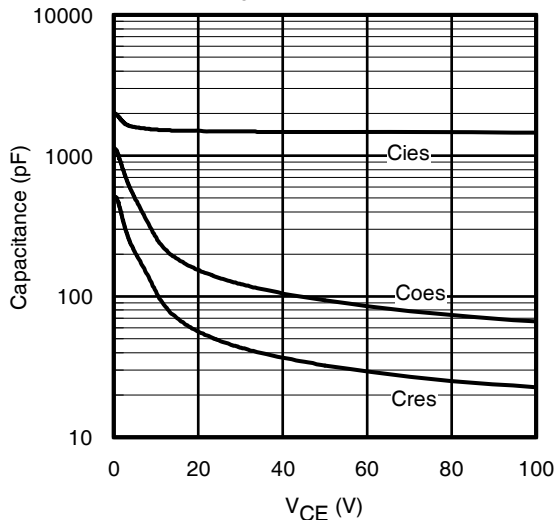
**Fig. 20** - Typ. Diode  $Q_{RR}$  vs.  $di_F/dt$   
 $V_{CC} = 400V$ ;  $V_{GE} = 15V$ ;  $T_J = 175^\circ C$



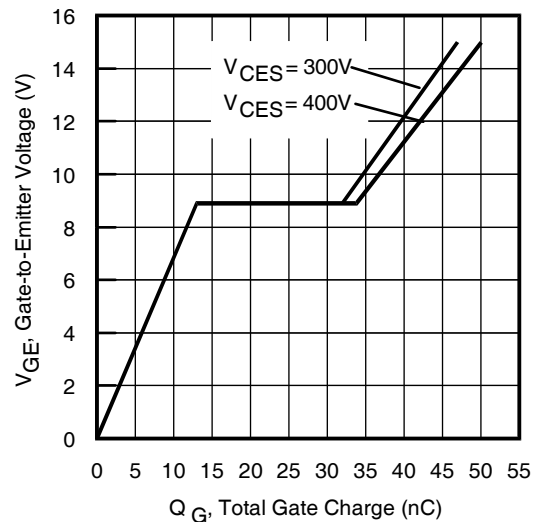
**Fig. 21** - Typ. Diode  $E_{RR}$  vs.  $I_F$   
 $T_J = 175^\circ C$



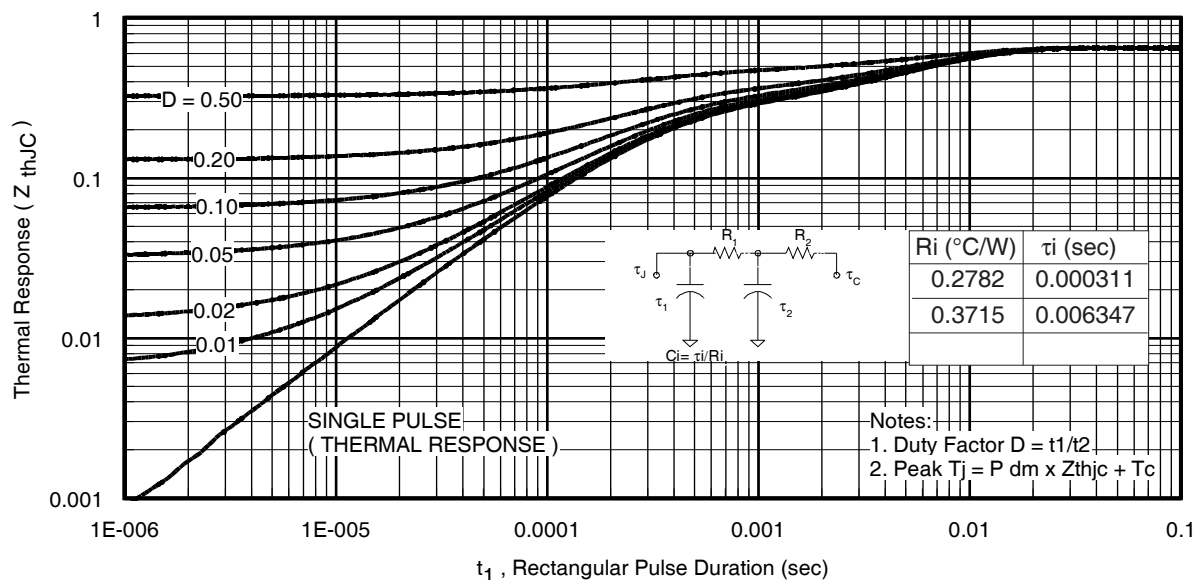
**Fig. 22** -  $V_{GE}$  vs. Short Circuit Time  
 $V_{CC} = 400V$ ;  $T_C = 25^\circ C$



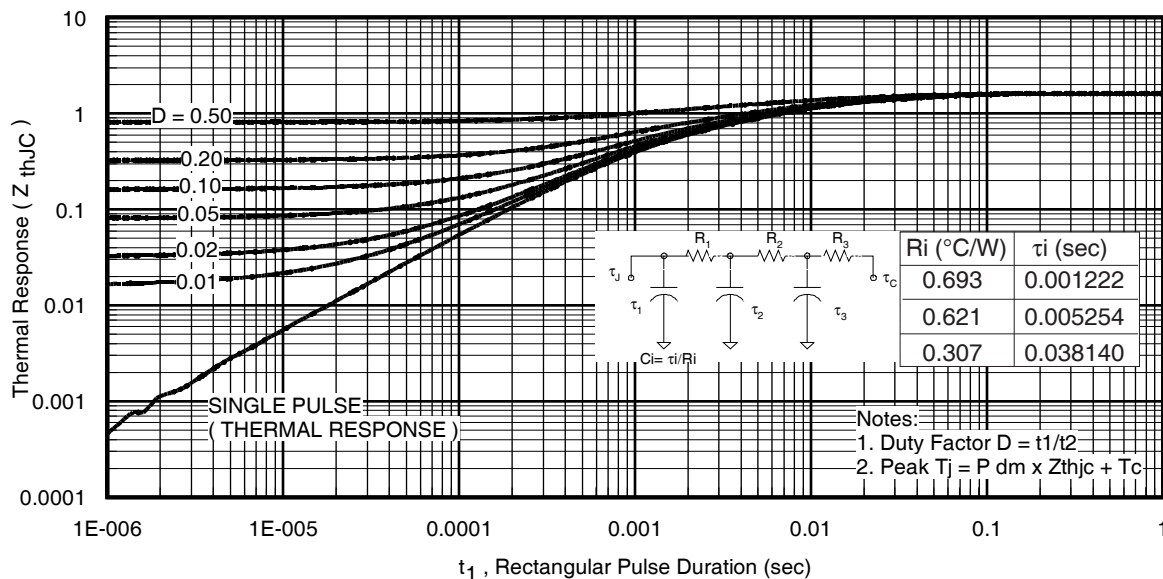
**Fig. 23** - Typ. Capacitance vs.  $V_{CE}$   
 $V_{GE} = 0V$ ;  $f = 1MHz$



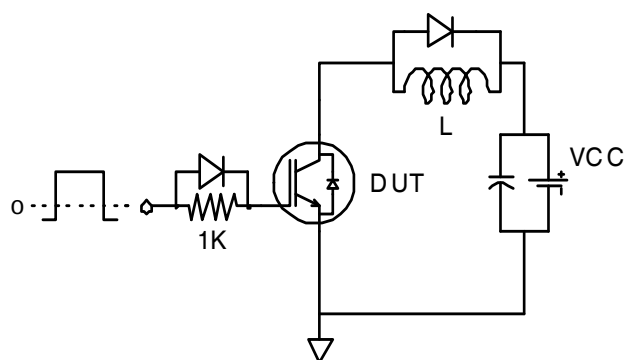
**Fig. 24** - Typical Gate Charge vs.  $V_{GE}$   
 $I_{CE} = 24A$ ;  $L = 600\mu H$



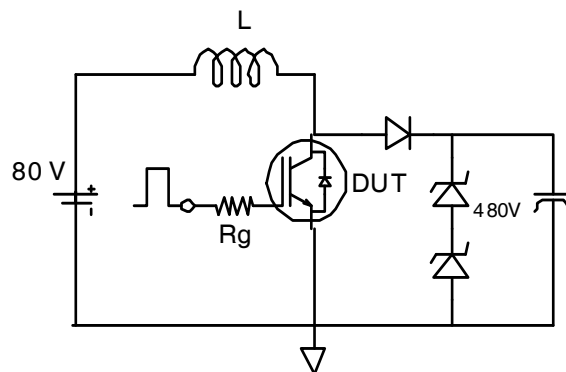
**Fig 27.** Maximum Transient Thermal Impedance, Junction-to-Case (IGBT) TO-247AC



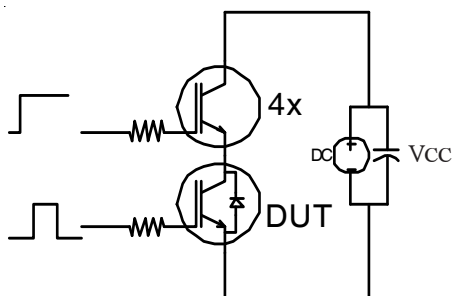
**Fig. 28.** Maximum Transient Thermal Impedance, Junction-to-Case (DIODE) TO-247AC



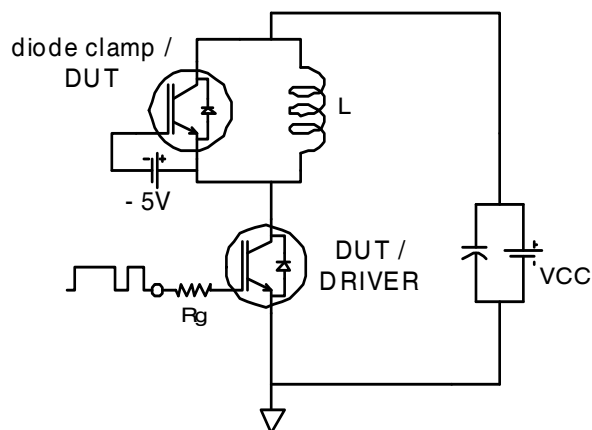
**Fig.C.T.1** - Gate Charge Circuit (turn-off)



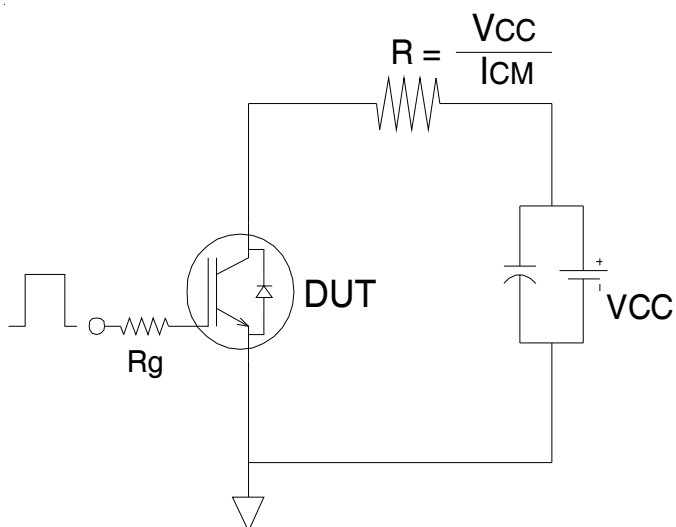
**Fig.C.T.2** - RBSOA Circuit



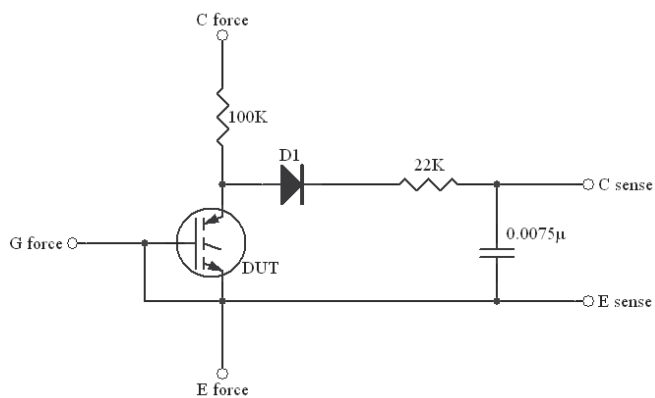
**Fig.C.T.3** - S.C. SOA Circuit



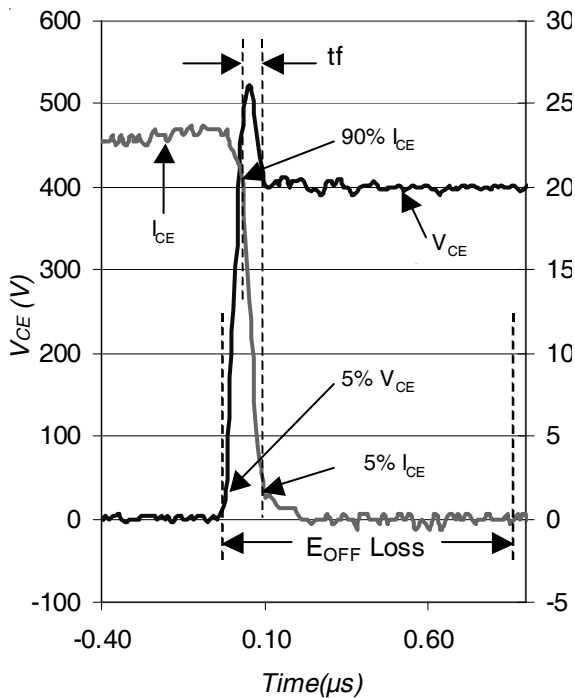
**Fig.C.T.4** - Switching Loss Circuit



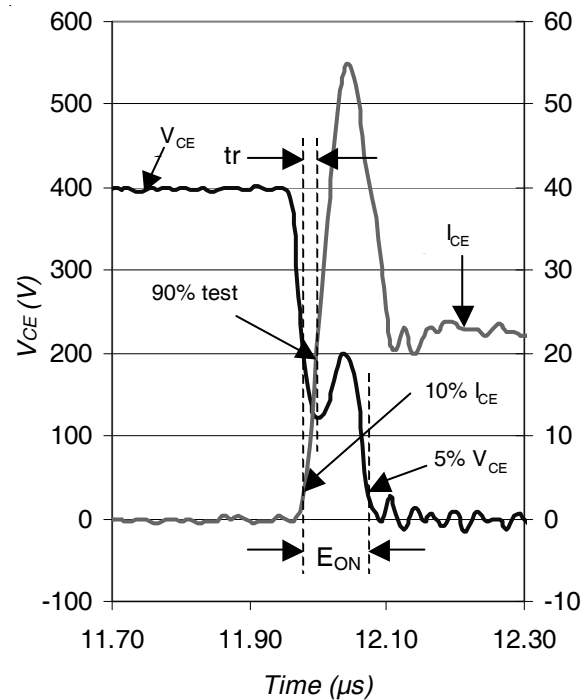
**Fig.C.T.5** - Resistive Load Circuit



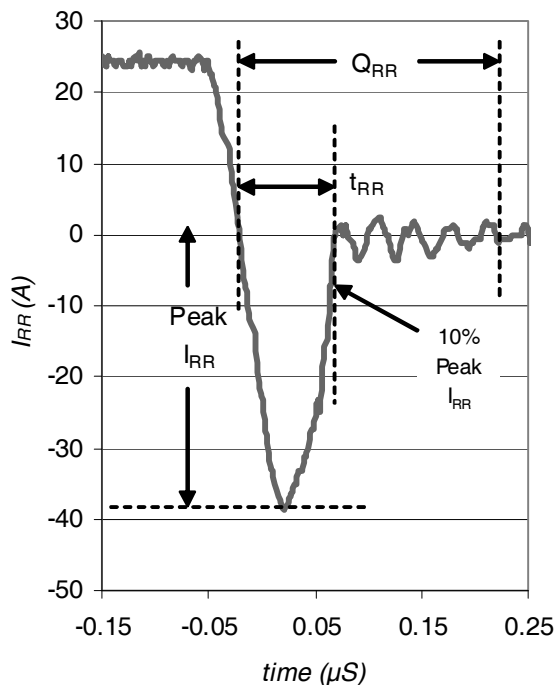
**Fig.C.T.6** - BVCES Filter Circuit



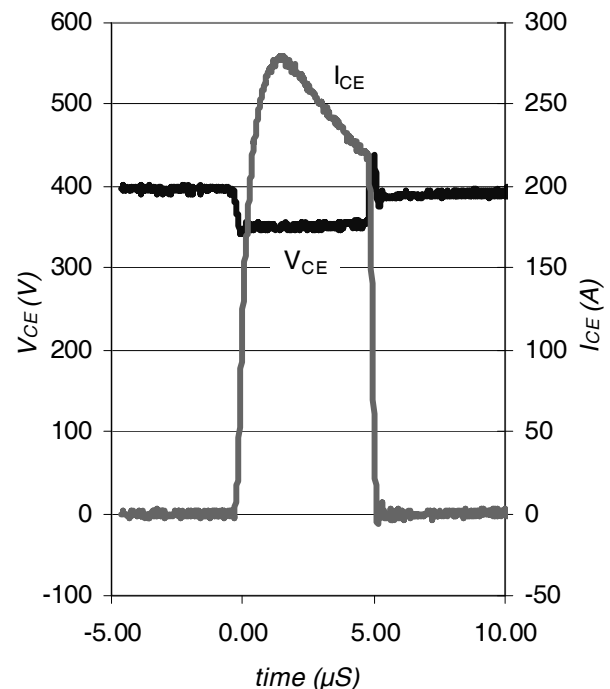
**Fig. WF1** - Typ. Turn-off Loss Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



**Fig. WF2** - Typ. Turn-on Loss Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



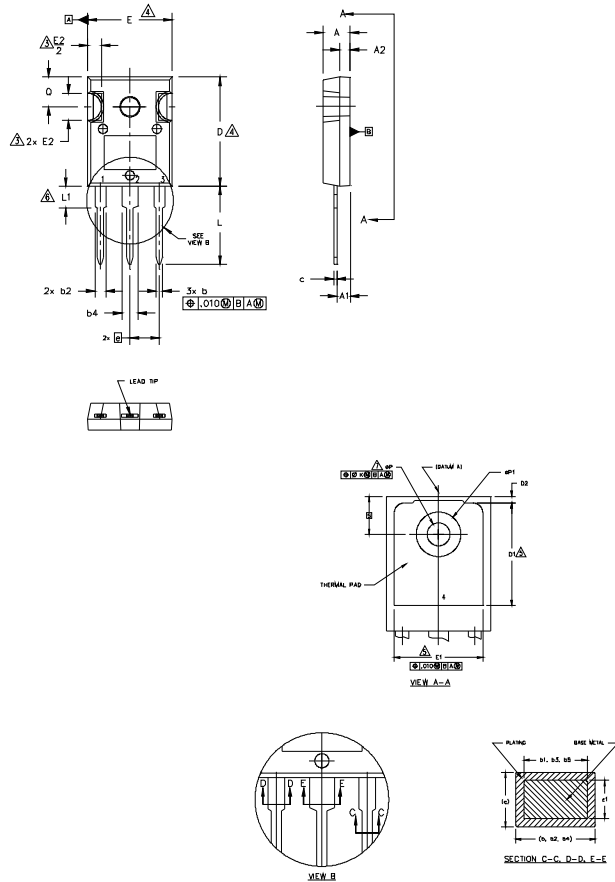
**Fig. WF3** - Typ. Diode Recovery Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



**Fig. WF4** - Typ. S.C. Waveform  
@  $T_J = 25^\circ\text{C}$  using Fig. CT.3

## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



### NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
2. DIMENSIONS ARE SHOWN IN INCHES.
3. CONTOUR OF SLOT OPTIONAL.
4. DIMENSION D & E DO NOT INCLUDE MOLD FLASH; MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
5. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
6. LEAD FINISH UNCONTROLLED IN L1.
7. pP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5 ° TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.
8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-247AC .

| SYMBOL | DIMENSIONS |      |             |       | NOTES |
|--------|------------|------|-------------|-------|-------|
|        | INCHES     |      | MILLIMETERS |       |       |
|        | MIN.       | MAX. | MIN.        | MAX.  |       |
| A      | .183       | .209 | 4.65        | 5.31  |       |
| A1     | .087       | .102 | 2.21        | 2.59  |       |
| A2     | .059       | .098 | 1.50        | 2.49  |       |
| b      | .039       | .055 | 0.99        | 1.40  |       |
| b1     | .039       | .053 | 0.99        | 1.35  |       |
| b2     | .065       | .094 | 1.65        | 2.39  |       |
| b3     | .065       | .092 | 1.65        | 2.34  |       |
| b4     | .102       | .135 | 2.59        | 3.43  |       |
| b5     | .102       | .133 | 2.59        | 3.38  |       |
| c      | .015       | .035 | 0.38        | 0.89  |       |
| c1     | .015       | .033 | 0.38        | 0.84  |       |
| D      | .776       | .815 | 19.71       | 20.70 | 4     |
| D1     | .515       | -    | 13.08       | -     | 5     |
| D2     | .020       | .053 | 0.51        | 1.35  |       |
| E      | .602       | .625 | 15.29       | 15.87 | 4     |
| E1     | .530       | -    | 13.46       | -     |       |
| E2     | .178       | .216 | 4.52        | 5.49  |       |
| e      | .215 BSC   |      | 5.46 BSC    |       |       |
| e1     | .100       |      | 0.25        |       |       |
| L      | .559       | .634 | 14.20       | 16.10 |       |
| L1     | .146       | .169 | 3.71        | 4.29  |       |
| pP     | .140       | .144 | 3.56        | 3.66  |       |
| pP1    | -          | .291 | -           | 7.39  |       |
| Q      | .209       | .224 | 5.31        | 5.69  |       |
| S      | .217 BSC   |      | 5.51 BSC    |       |       |

### LEAD ASSIGNMENTS

#### HEXFET

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

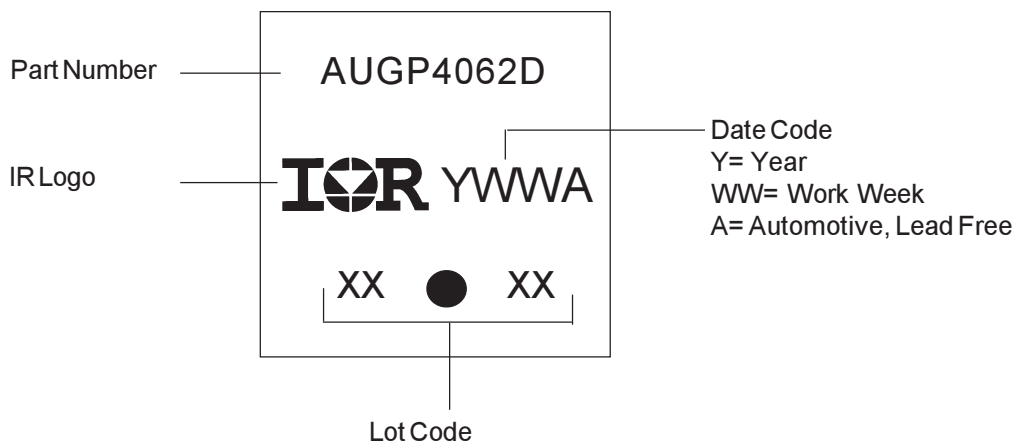
#### IGBTs, CoPACK

- 1.- GATE
- 2.- COLLECTOR
- 3.- EMITTER
- 4.- COLLECTOR

#### DIODES

- 1.- ANODE/OPEN
- 2.- CATHODE
- 3.- ANODE

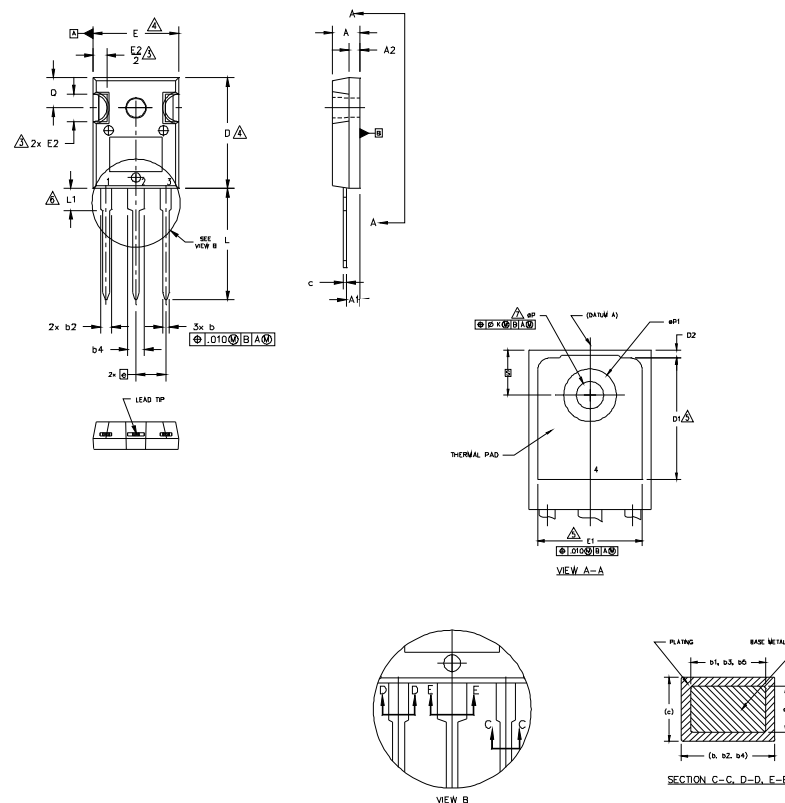
## TO-247AC Part Marking Information



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

## TO-247AD Package Outline

Dimensions are shown in millimeters (inches)



### NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
2. DIMENSIONS ARE SHOWN IN INCHES.
3. CONTOUR OF SLOT OPTIONAL.
4. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
5. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
6. LEAD FINISH UNCONTROLLED IN L1.
7. ØP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5 ° TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.
8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-247AD.

| SYMBOL | DIMENSIONS |      |             |       | NOTES |
|--------|------------|------|-------------|-------|-------|
|        | INCHES     |      | MILLIMETERS |       |       |
|        | MIN.       | MAX. | MIN.        | MAX.  |       |
| A      | .183       | .209 | 4.65        | 5.31  |       |
| A1     | .087       | .102 | 2.21        | 2.59  |       |
| A2     | .059       | .098 | 1.50        | 2.49  |       |
| b      | .039       | .055 | 0.99        | 1.40  |       |
| b1     | .039       | .053 | 0.99        | 1.35  |       |
| b2     | .065       | .094 | 1.65        | 2.39  |       |
| b3     | .065       | .092 | 1.65        | 2.34  |       |
| b4     | .102       | .135 | 2.59        | 3.43  |       |
| b5     | .102       | .133 | 2.59        | 3.38  |       |
| c      | .015       | .035 | 0.38        | 0.89  |       |
| c1     | .015       | .033 | 0.38        | 0.84  |       |
| D      | .776       | .815 | 19.71       | 20.70 | 4     |
| D1     | .515       | —    | 13.08       | —     | 5     |
| D2     | .020       | .053 | 0.51        | 1.35  |       |
| E      | .602       | .625 | 15.29       | 15.87 | 4     |
| E1     | .530       | —    | 13.46       | —     |       |
| E2     | .178       | .216 | 4.52        | 5.49  |       |
| e      | .215 BSC   |      | 5.46 BSC    |       |       |
| Øk     | .010       |      | 0.25        |       |       |
| L      | .780       | .827 | 19.57       | 21.00 |       |
| L1     | .146       | .169 | 3.71        | 4.29  |       |
| ØP     | .140       | .144 | 3.56        | 3.66  |       |
| ØP1    | —          | .291 | —           | 7.39  |       |
| Q      | .209       | .224 | 5.31        | 5.69  |       |
| S      | .217 BSC   |      | 5.51 BSC    |       |       |

### LEAD ASSIGNMENTS

#### HEXFET

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

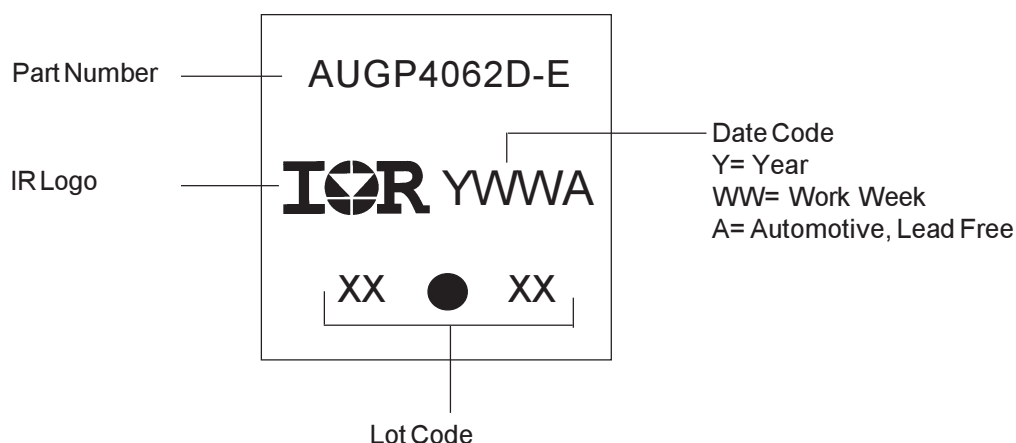
#### IGBTs, CoPACK

- 1.- GATE
- 2.- COLLECTOR
- 3.- EMITTER
- 4.- COLLECTOR

#### DIODES

- 1.- ANODE/OPEN
- 2.- CATHODE
- 3.- ANODE

## TO-247AD Part Marking Information



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

## Ordering Information

| Base part number | Package Type | Standard Pack |          | Complete Part Number |
|------------------|--------------|---------------|----------|----------------------|
|                  |              | Form          | Quantity |                      |
| AUIRGP4062D      | TO-247AC     | Tube          | 25       | AUIRGP4062D          |
| AUIRGP4062D-E    | TO-247AD     | Tube          | 25       | AUIRGP4062D-E        |

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